High-speed switching diode

Features

1. Glass sealed envelope.
2. High reliability.
3. High speed.

Applications

High speed switching

Construction

Silicon epitaxial planar

Absolute Maximum Ratings

T_a=25℃

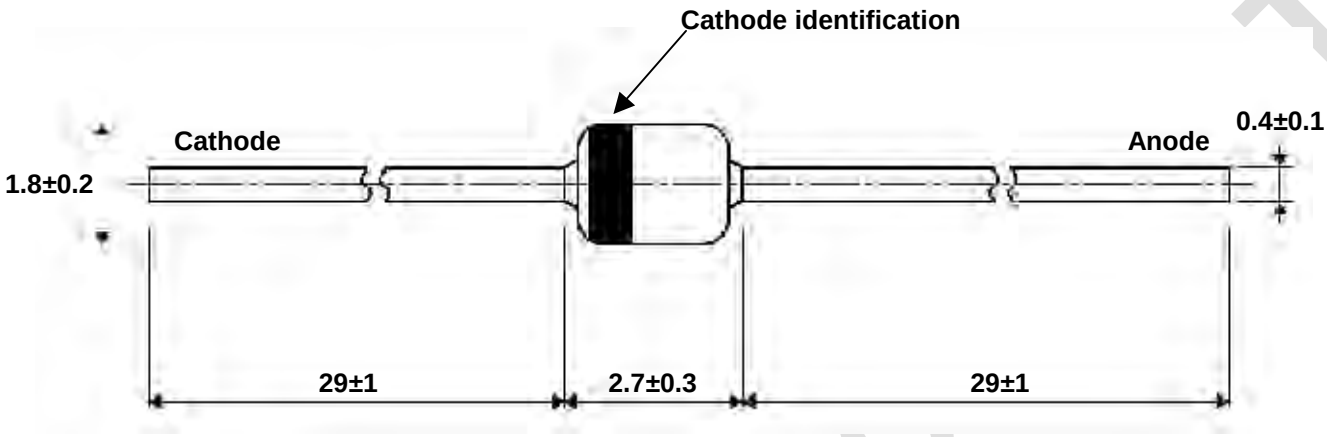
Parameter	Symbol	Limits	Unit	Parameter	Symbol	Value	Unit
Peak reverse voltage	V_{RM}	90	V	Surge current(1s)	I_{surge}	600	mA
DC reverse voltage	V_R	80	V	Power dissipation	P	300	mW
Peak forward current	I_{FM}	400	mA	Junction temperature	T_j	175	℃
Mean rectifying current	I_o	130	mA	Storage temperature	T_{stg}	-65~+175	℃

Electrical Characteristics

T_a=25℃

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_F	-	0.92	1.2	V	I_F=100mA
Reverse current	I_R	-	0.02	0.5	μA	V_R=80V
Capacitance between terminals	C_T	-	1.55	2	pF	V_R=0.5V,f=1MHz
Reverse recovery time	t_{rr}	-	1.5	4	ns	V_R=6V,I_F=10mA,R_L=50

Dimensions in mm



Standard Glass Case
JEDEC DO 34

Characteristics (Ta=25℃ unless specified otherwise)

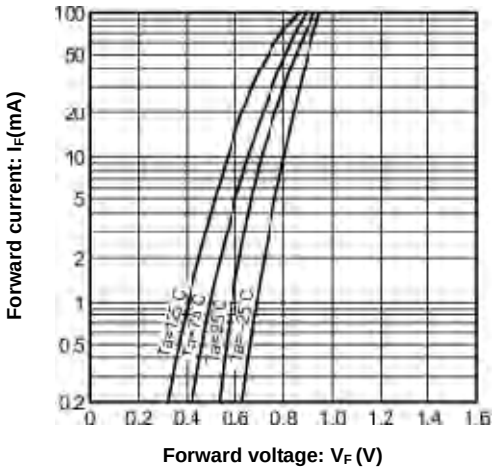


Figure 1. Forward characteristics

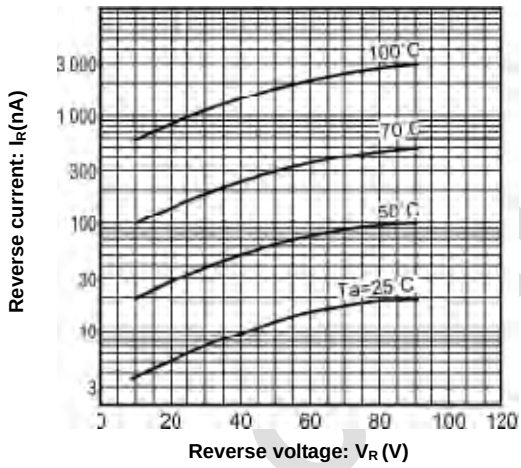


Figure 2. Reverse characteristics

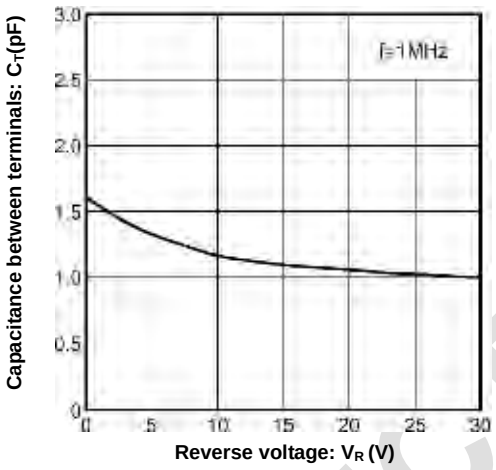


Figure 3. Capacitance between terminals characteristics

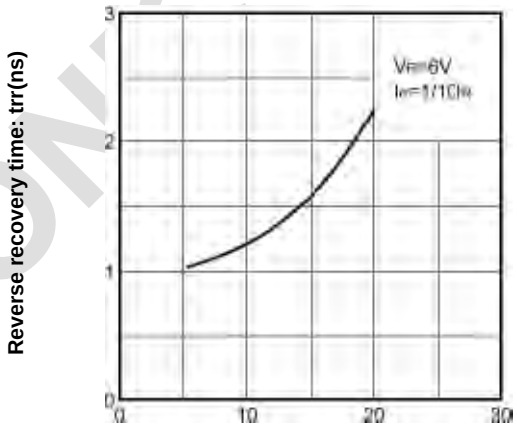


Figure 4. Reverse recovery time characteristics

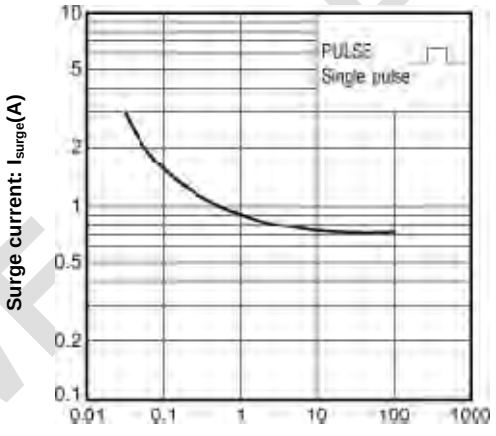


Figure 5. Surge current characteristics

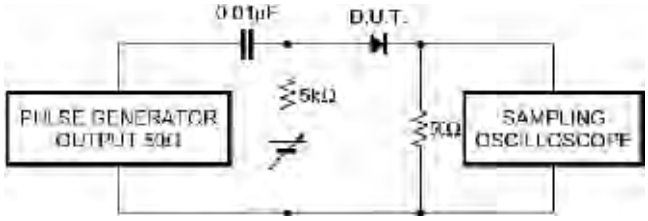


Figure 6. Reverse recovery time (trr) measurement circuit